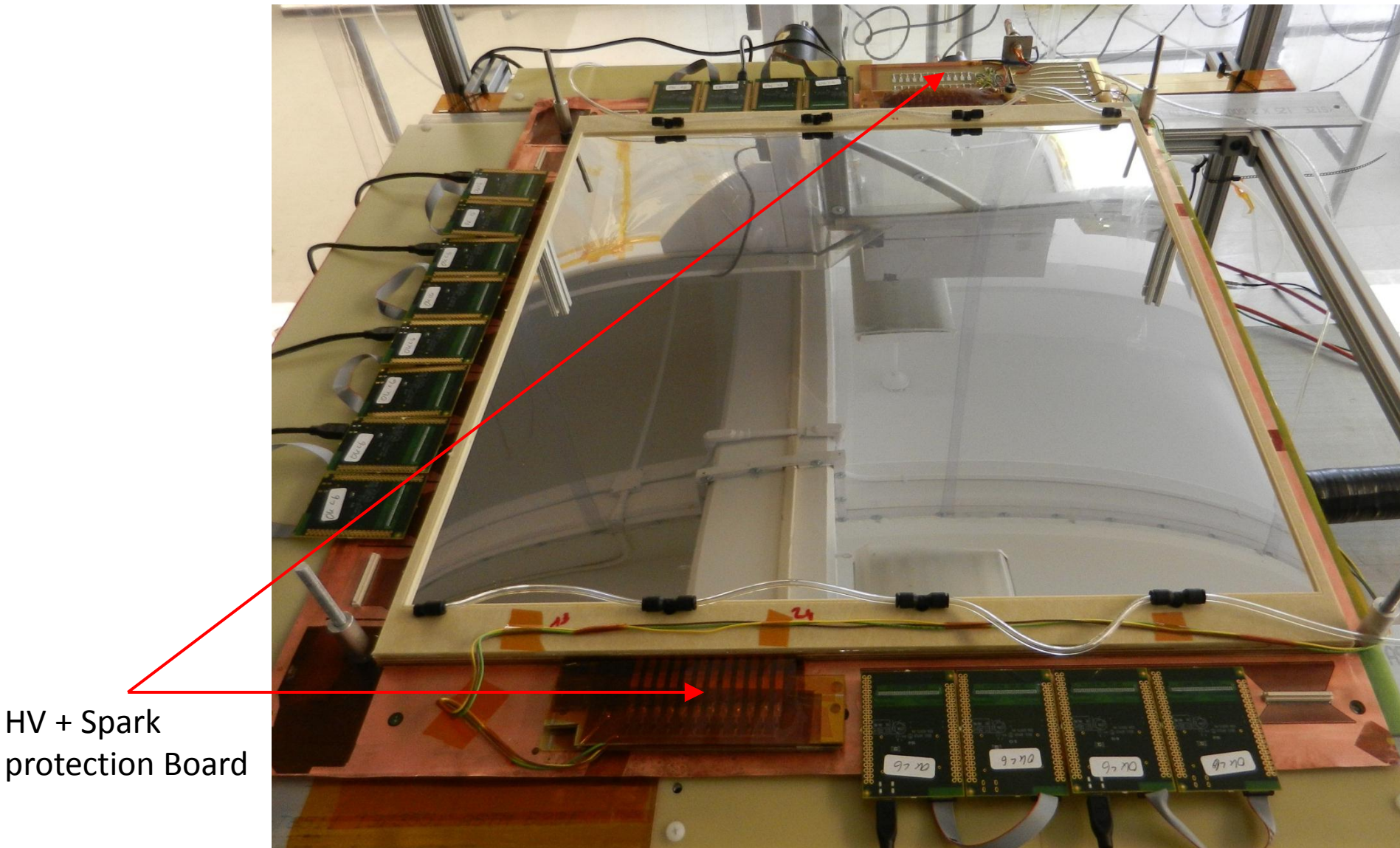
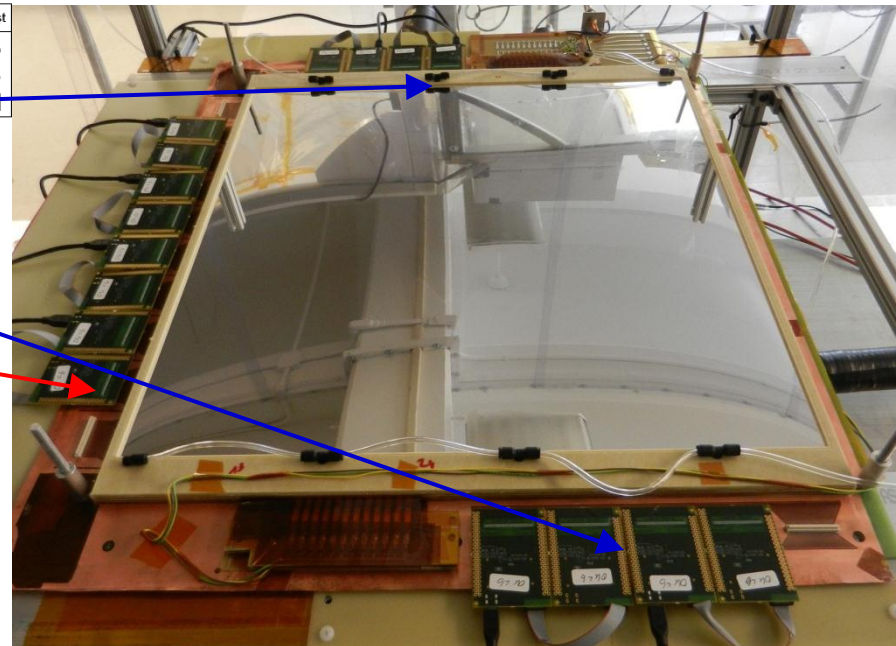
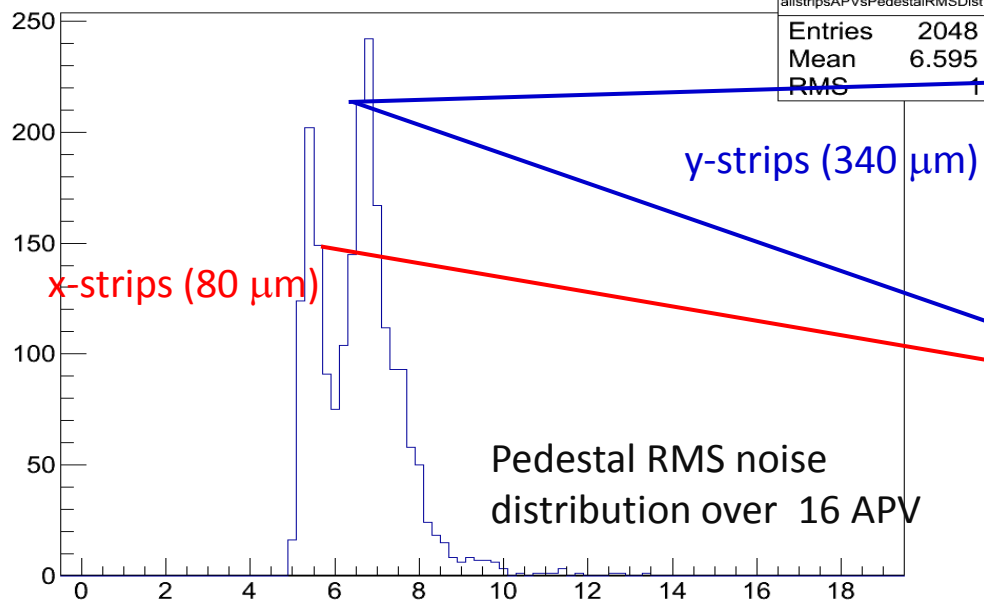


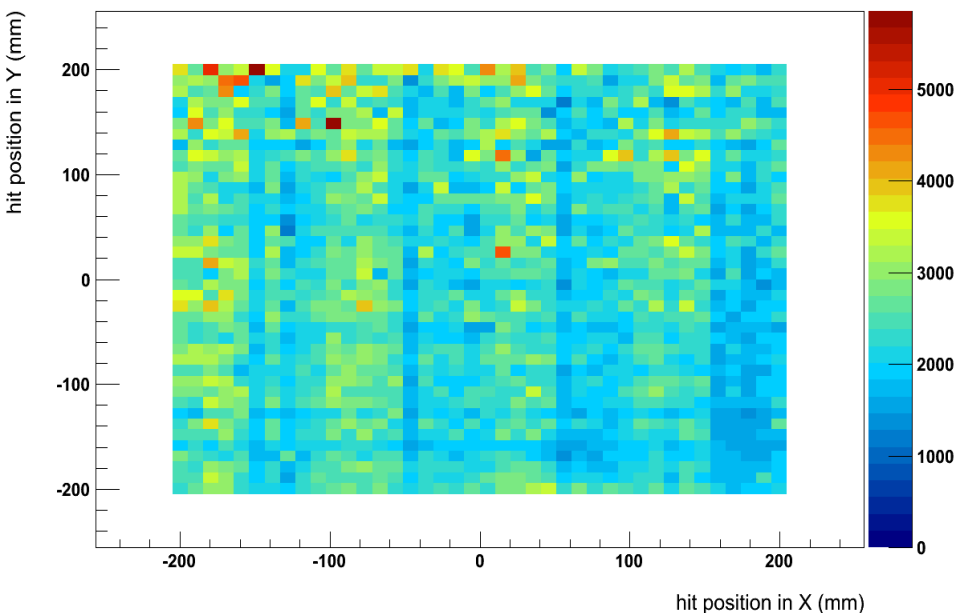
SBS Back Tracker $50 \times 50 \text{ cm}^2$ Triple GEM proto1



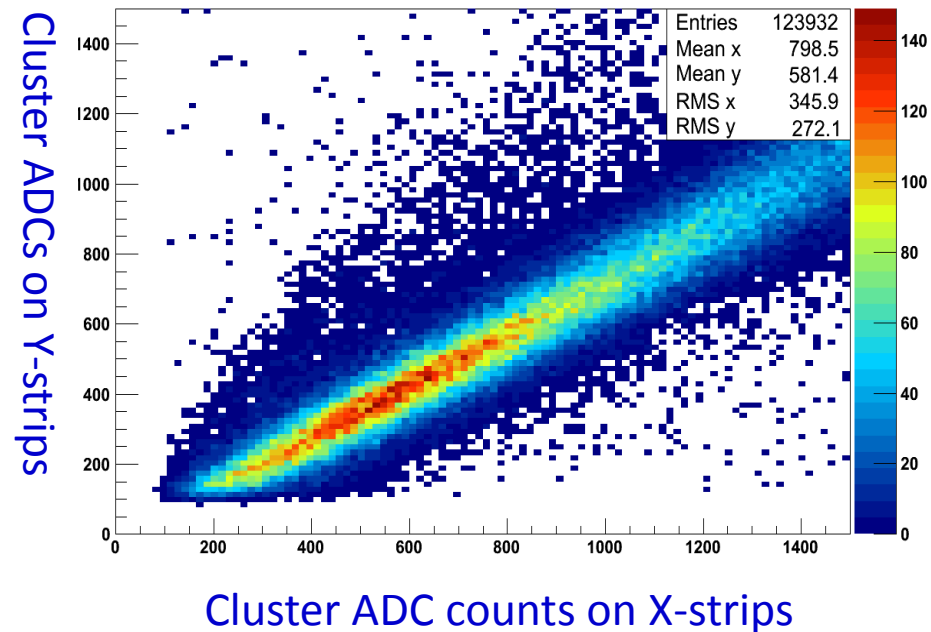
allstripsAPVsPedestalRMSDist



Mean ADC counts



SBS 50 cm x 50 cm Proto GEM1 2D Charge Sharing

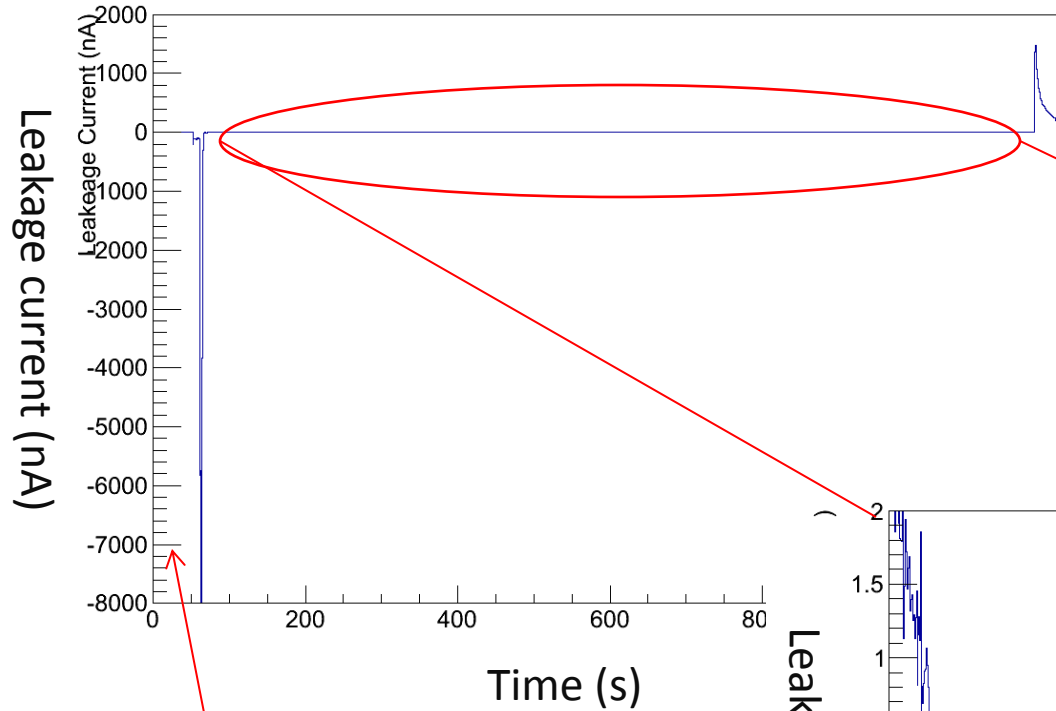


HV test procedure

- We use an Iseg EHS 8060x_105 6 kV HV module with a Wiener MPOD high voltage crate. High voltage is controlled using a command line interface through an internet protocol.
- For the test we use the fast ramp up mode of the supply with a rate of 1200 V/s. the power supply is sampling the current on a millisecond scale and the trip occurs within a few milliseconds of current over limit.
- The leakage current drawn by the GEM foil is measured using a Keithley 6487 picoammeter, at a sampling rate of 120 ms read into the computer through a Labview interface and save the readings into a text file.
- A GEM sector has a capacitance of approximately 2 nF; and the resistance engaged in the HV module is $\sim 50 \text{ M}\Omega$, once the stable voltage is achieved this resistance is shunted automatically within the supply). As a result, when we are setting the required high voltage of 550 V, the initial current is a couple of μA , then quickly drops and stabilizes to about less 1 nA leakage current far better than the 5 nA requirement.

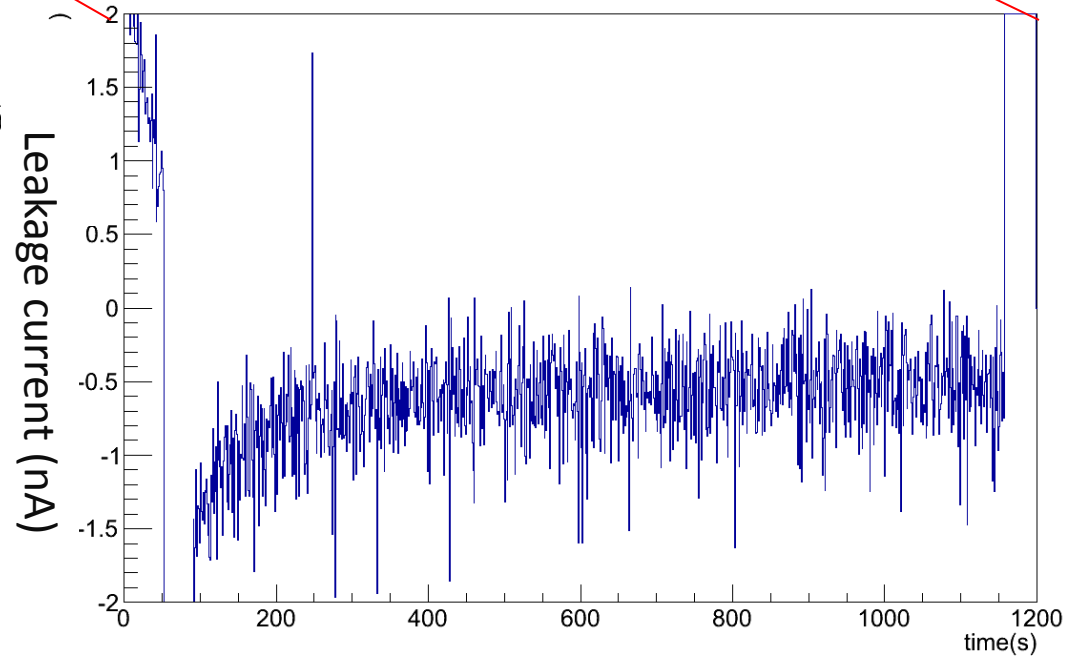
HV test of Sector16 from GEM2

testFramedFoil4Sector16



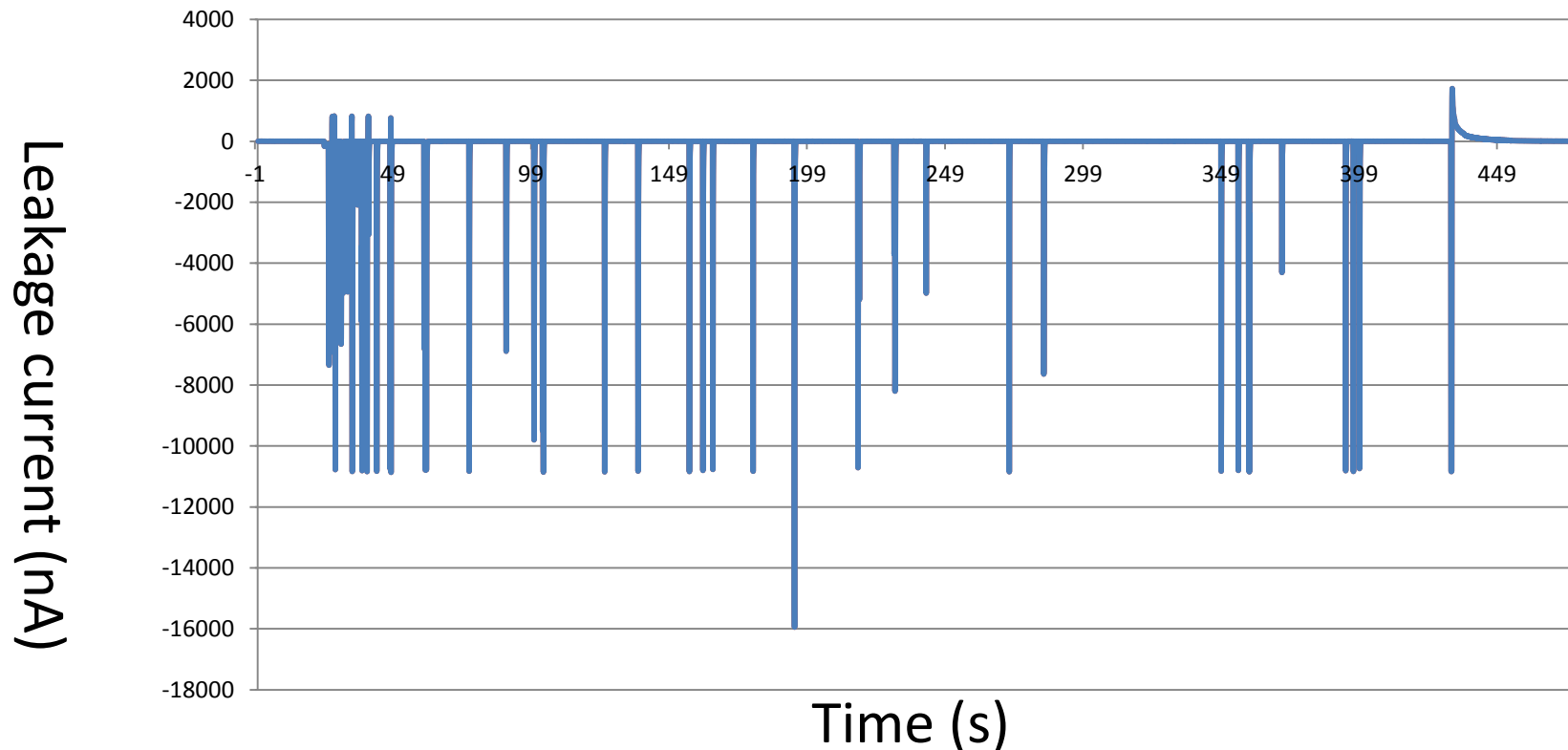
Initial current when
applying the HV

testFramedFoil4Sector16



Spark rate and amplitude on a dirty foil

- We tested the HV test procedure using a small 10 cm x10 cm GEM foil in the N2 box.
- Before the test, it was allowed to collect dust for 10 minutes outside the clean room.
- Series of current spikes corresponding to sparks in the GEM foil arising from dust particles burning.
 - The spike lasts a couple of hundred ms and current up 15 μA . Sparks are visible and audible.
 - After the spark the current goes down to ~ 1 nA level with no burn marks in the foil afterwards.
 - The spark rate decreases with time and the current stable at < 1 nA.



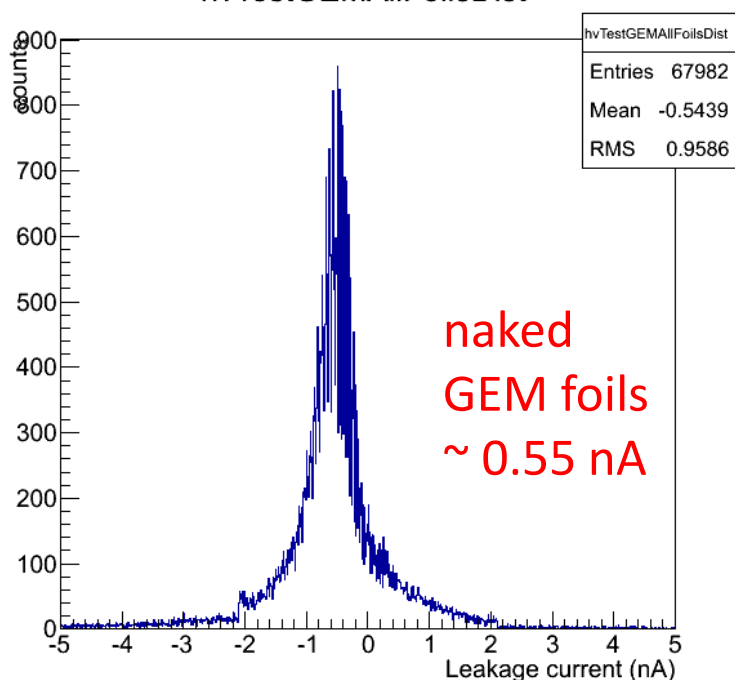
What we learned

- **Do not** ramp up the HV slowly from 0 to 550 to test the foil instead one should directly apply the nominal test HV
 - ➔ See Rui's talk for explanation
- Limitation of the current should be set high enough to avoid trip and allow burning of the dust on the foil
 - ➔ In our case we set it at 15 μA
 - ➔ A trip of the HV power supply can be as bad as ramping the HV slowly
- When a sector has a lot of sparks and do not stabilize with 20 s ➔ stop the HV and let it dry under N₂ for a couple of days
 - ➔ If the problem persists, send the foil back to Rui

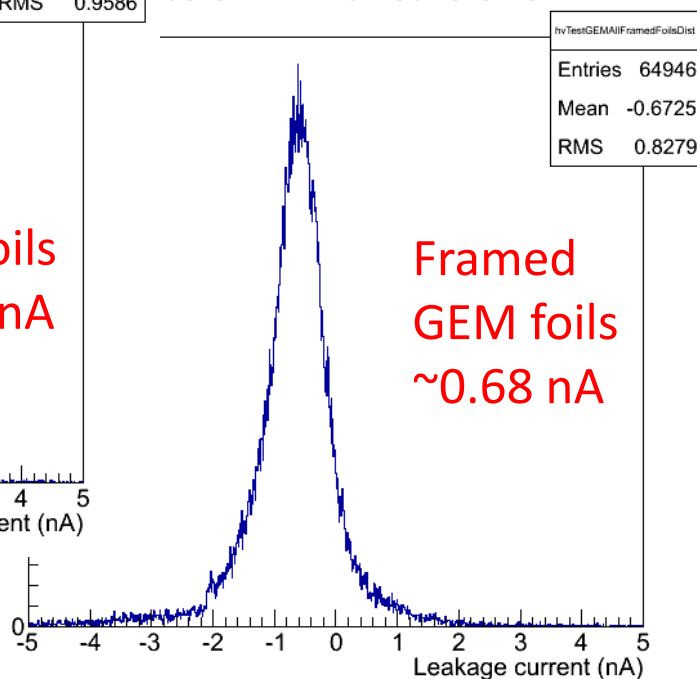
HV test during the assembly of Proto1

- Distribution of leakage current over all the 72 sectors
- 24 sectors per foil → 3 foils → 72 sectors
- HV test at 550 V under N2 for naked, framed foils and in chamber foils

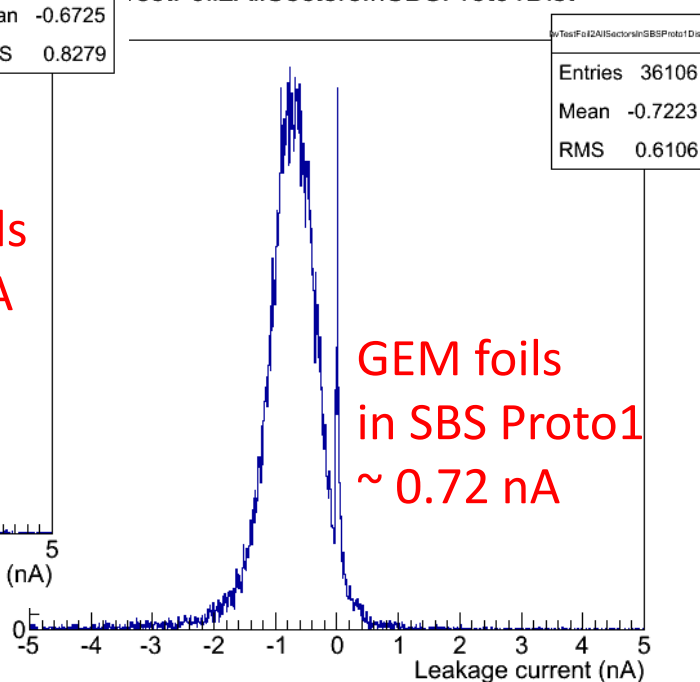
hvTestGEMAllFoilsDist



TestGEMAllFramedFoilsDist



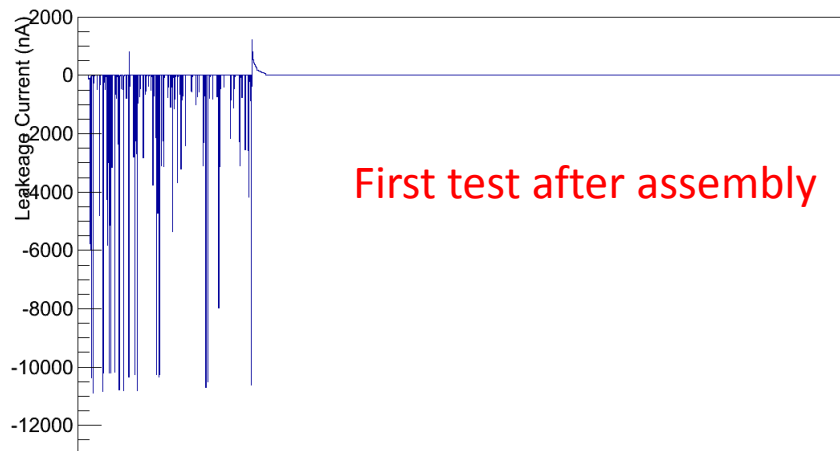
TestFoil2AllSectorsInSBSProto1Dist



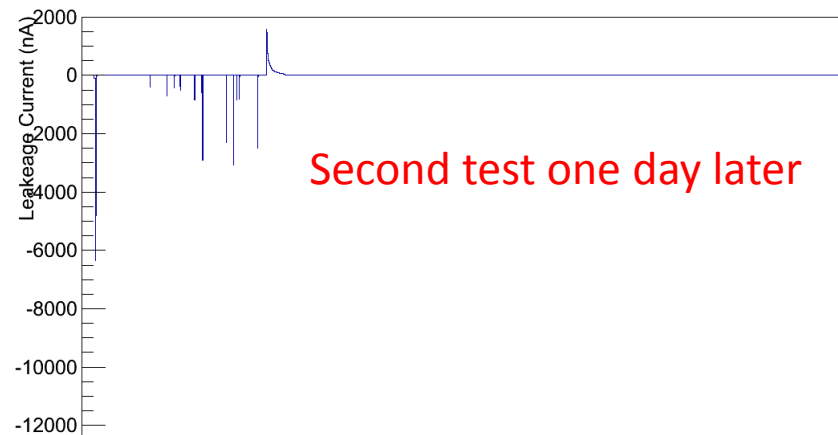
Curing of the sector12 on GEM1

Excess of glue leaked onto the sector during assembly → sector can be recovered
after curing on N₂ or at 50 degree

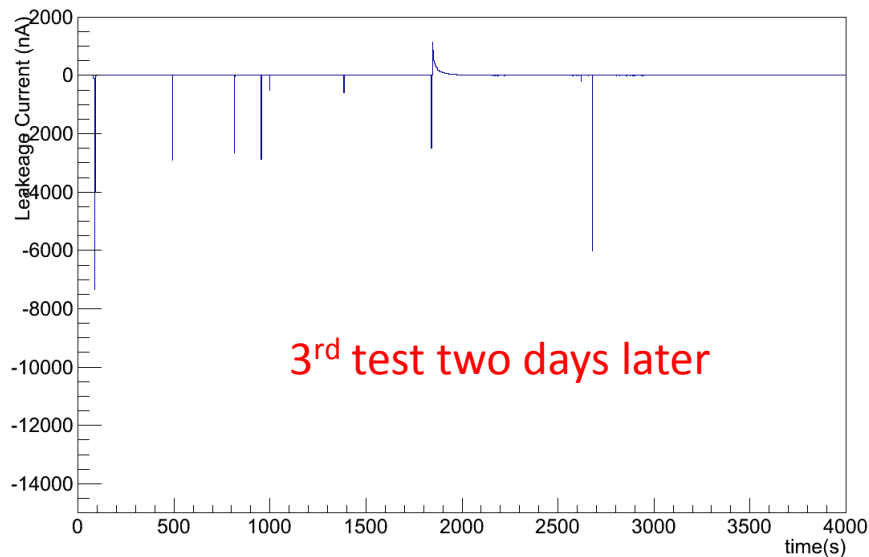
hvTestSBSPProto1Foil2Sector12



hvTestSBSPProto1Foil2Sector12_retest



hvTestSBSPProto1Foil2Sector12_retest2



hvTestSBSPProto1Foil2Sector12_retest2

